

2SC2853

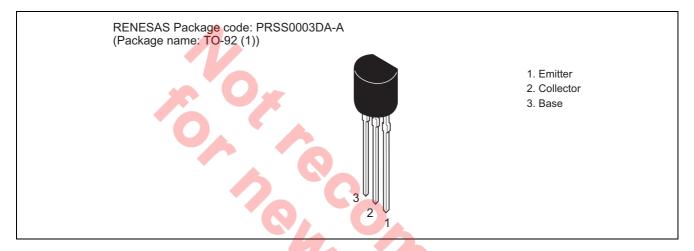
Silicon NPN Epitaxial

REJ03G0708-0300 (Previous ADE-208-1078A) Rev.3.00 Aug.10.2005

Application

Low frequency amplifier

Outline



Absolute Maximum Ratings

 $(Ta = 25^{\circ}C)$

Item	Symbol	Ratings	Unit
Collector to base voltage	V _{CBO}	90	V
Collector to emitter voltage	V _{CEO}	90	V
Emitter to base voltage	V _{EBO}	5	V
Collector current	Ic	100	mA
Emitter current	I _E	-100	mA
Collector power dissipation	P _C	400	mW
Junction temperature	Tj	150	°C
Storage temperature	Tstg	-55 to +150	°C

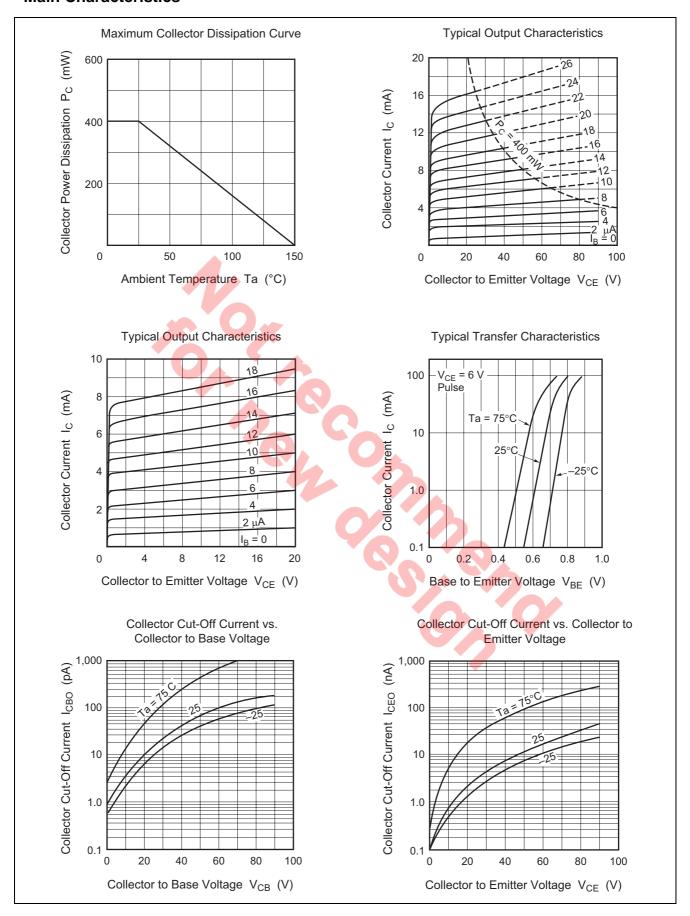
Electrical Characteristics

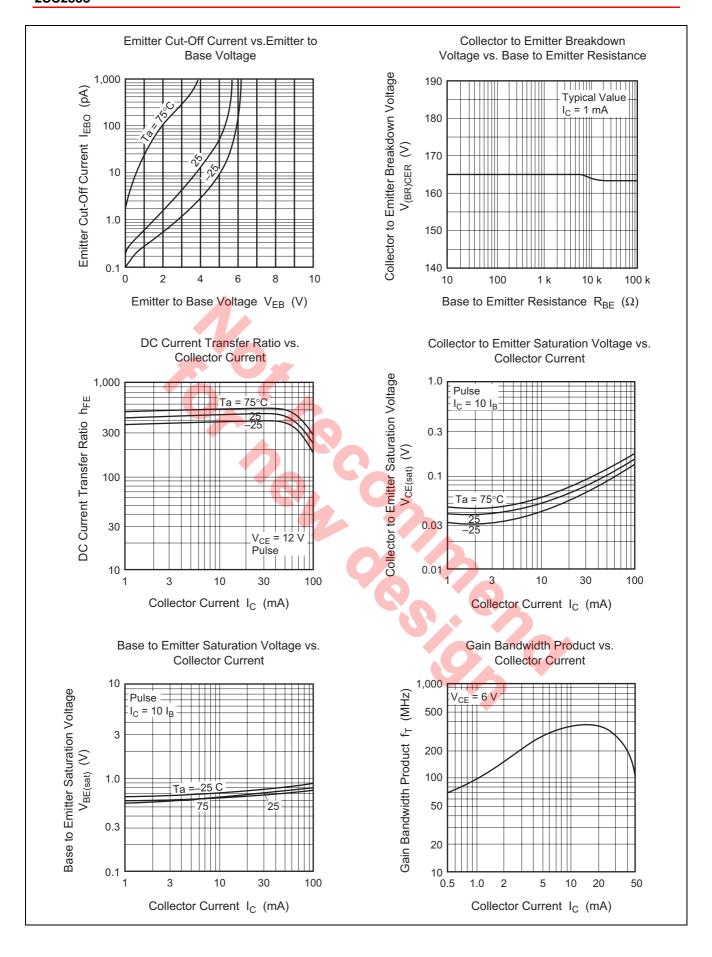
 $(Ta = 25^{\circ}C)$

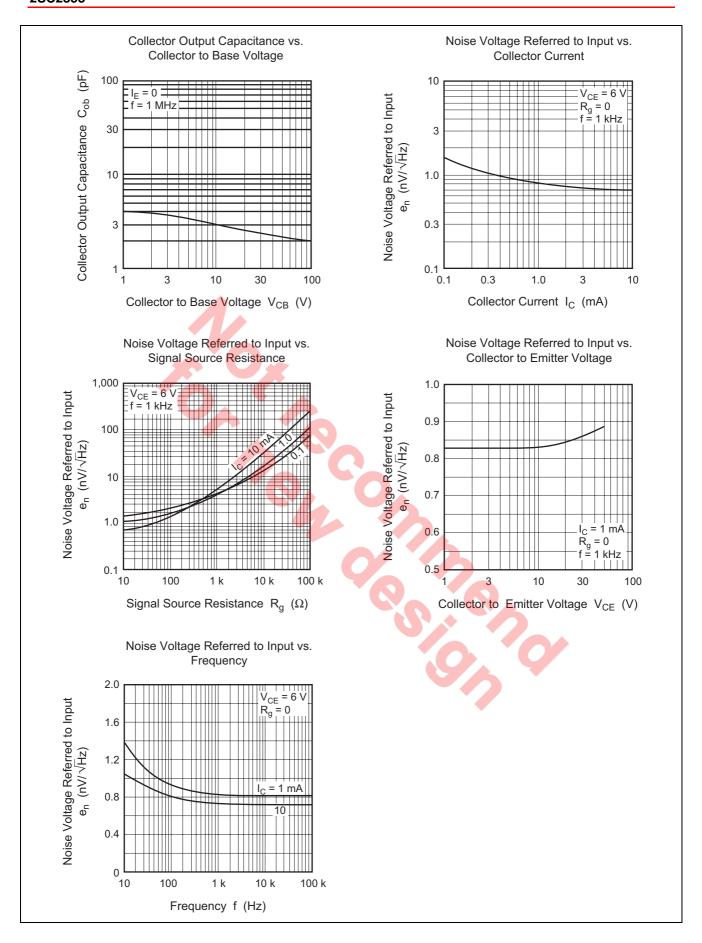
Item	Symbol	Min	Тур	Max	Unit	Test conditions
Collector to base breakdown voltage	$V_{(BR)CBO}$	90	_	_	V	$I_C = 10 \mu A, I_E = 0$
Collector to emitter breakdown voltage	$V_{(BR)CEO}$	90	_	_	V	$I_C = 1 \text{ mA}, R_{BE} = \infty$
Emitter to base breakdown voltage	$V_{(BR)EBO}$	5	_	_	V	$I_E = 10 \mu A, I_C = 0$
Collector cutoff current	I _{CBO}	_	_	0.1	μΑ	$V_{CB} = 70 \text{ V}, I_{E} = 0$
Emitter cutoff current	I _{EBO}	_	_	0.1	μΑ	$V_{EB} = 2 \text{ V}, I_{C} = 0$
DC current transfer ratio	h _{FE}	400	_	800		V _{CE} = 12 V, I _C = 2 mA
Collector to emitter saturation voltage	V _{CE(sat)}	_	0.05	0.10	V	I _C = 10 mA, I _B = 1 mA
Base to emitter saturation voltage	V _{BE(sat)}	_	0.7	1.0	V	
Gain bandwidth product	f⊤	_	310	_	MHz	$V_{CE} = 6 \text{ V}, I_{C} = 10 \text{ mA}$
Collector output capacitance	Cob	_	3	_	pF	$V_{CB} = 10 \text{ V}, I_{E} = 0,$
						f = 1 MHz



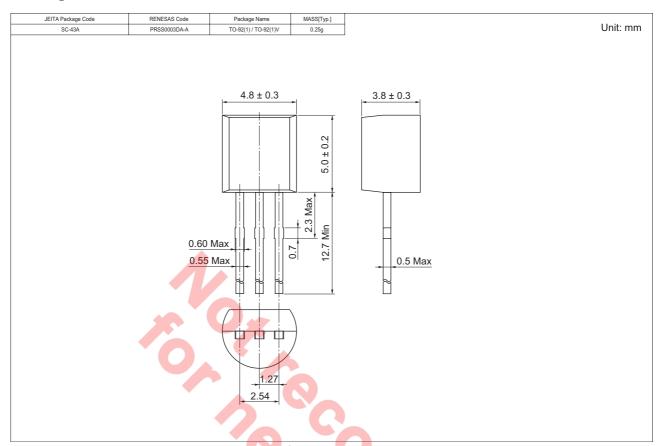
Main Characteristics







Package Dimensions



Ordering Information

Part Name	Quantity	Shipping Container
2SC2853ETZ-E	2500	Hold Box, Radial Taping

Note: For some grades, production may be terminated. Please contact the Renesas sales office to check the state of production before ordering the product.

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